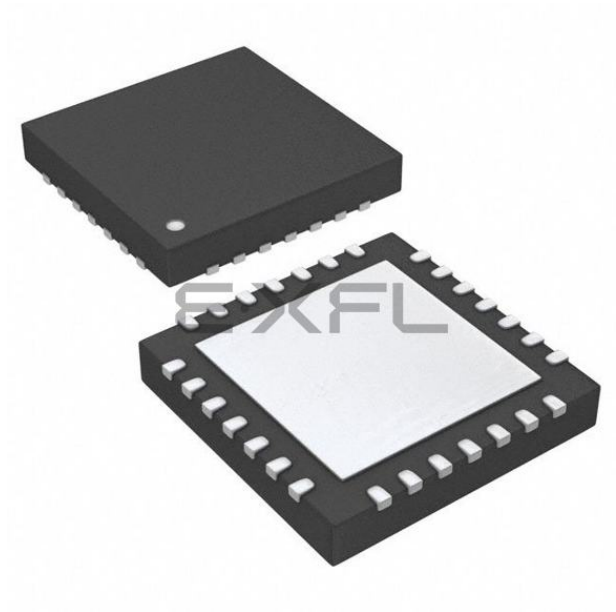

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Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	25
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 24x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf18854-i-ml

TABLE 3-11: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-31 (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on all other Resets
Bank 5											
CPU CORE REGISTERS; see Table 3-2 for specifics											
28Ch	T2TMR	Holding Register for the 8-bit TMR2 Register								0000 0000	0000 0000
28Dh	T2PR	TMR2 Period Register								1111 1111	1111 1111
28Eh	T2CON	ON	CKPS<2:0>			OUTPS<3:0>				0000 0000	0000 0000
28Fh	T2HLT	PSYNC	CKPOL	CKSYNC	—	MODE				000- 0000	000- 0000
290h	T2CLKCON	—	—	—	—	—	CS<2:0>			---- -000	---- -000
291h	T2RST	—	—	—	RSEL<4:0>					---0 0000	---0 0000
292h	T4TMR	Holding Register for the 8-bit TMR4 Register								0000 0000	0000 0000
293h	T4PR	TMR4 Period Register								1111 1111	1111 1111
294h	T4CON	ON	CKPS<2:0>			OUTPS<3:0>				0000 0000	0000 0000
295h	T4HLT	PSYNC	CKPOL	CKSYNC	—	MODE<3:0>				000- 0000	000- 0000
296h	T4CLKCON	—	—	—	—	—	CS<2:0>			---- -000	---- -000
297h	T4RST	—	—	—	RSEL<4:0>					---0 0000	---0 0000
298h	T6TMR	Holding Register for the 8-bit TMR6 Register								0000 0000	0000 0000
299h	T6PR	TMR6 Period Register								1111 1111	1111 1111
29Ah	T6CON	ON	CKPS<2:0>			OUTPS<3:0>				0000 0000	0000 0000
29Bh	T6HLT	PSYNC	CKPOL	CKSYNC	—	MODE<3:0>				000- 0000	000- 0000
29Ch	T6CLKCON	—	—	—	—	—	CS<2:0>			---- -000	---- -000
29Dh	T6RST	—	—	—	RSEL<4:0>					---0 0000	---0 0000
29Eh	—	Unimplemented								—	—
29Fh	—	Unimplemented								—	—

Legend: x = unknown, u = unchanged, q =depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

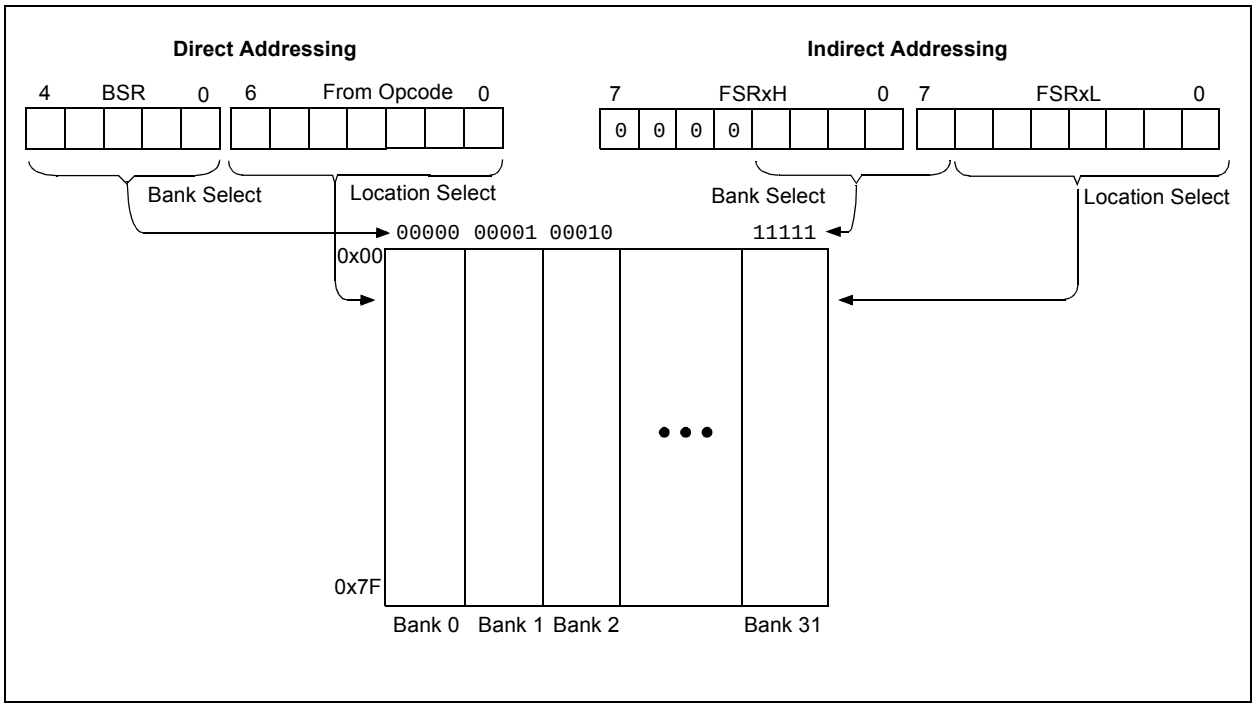
Note 1: Register present on PIC16F18854 devices only.

2: Unimplemented, read as '1'.

3.5.1 TRADITIONAL DATA MEMORY

The traditional data memory is a region from FSR address 0x000 to FSR address 0xFFF. The addresses correspond to the absolute addresses of all SFR, GPR and common registers.

FIGURE 3-9: TRADITIONAL DATA MEMORY MAP



5.12 Power Control (PCON) Register

The Power Control (PCON) register contains flag bits to differentiate between a:

- Power-on Reset ($\overline{POR}$)
- Brown-out Reset ($\overline{BOR}$)
- Reset Instruction Reset ($\overline{RI}$)
- $\overline{MCLR}$ Reset ($\overline{RMCLR}$)
- Watchdog Timer Reset ($\overline{RWDT}$)
- Watchdog Timer Window Violation Reset ($\overline{WDTWV}$)
- Stack Underflow Reset (STKUNF)
- Stack Overflow Reset (STKOVF)

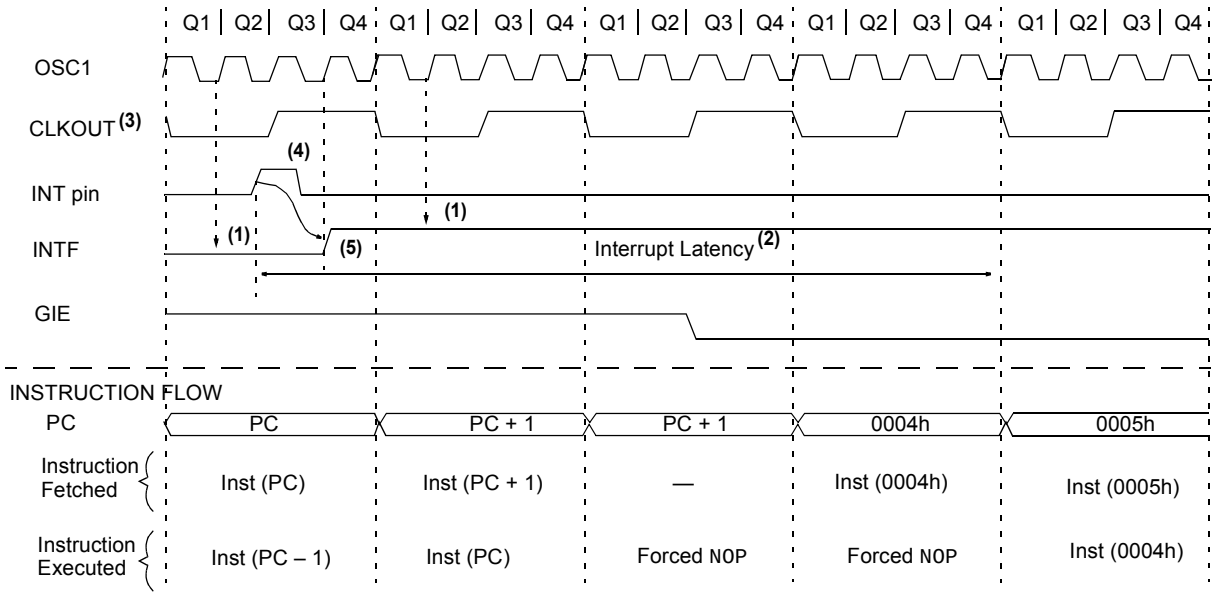
The PCON0 register bits are shown in Register 5-2.

Hardware will change the corresponding register bit during the Reset process; if the Reset was not caused by the condition, the bit remains unchanged (Table 5-4).

Software should reset the bit to the inactive state after the restart (hardware will not reset the bit).

Software may also set any PCON bit to the active state, so that user code may be tested, but no reset action will be generated.

FIGURE 7-3: INT PIN INTERRUPT TIMING



Note 1: INTF flag is sampled here (every Q1).

2: Asynchronous interrupt latency = 3-5 TCY. Synchronous latency = 3-4 TCY, where TCY = instruction cycle time. Latency is the same whether Inst (PC) is a single cycle or a 2-cycle instruction.

3: CLKOUT not available in all oscillator modes.

4: For minimum width of INT pulse, refer to AC specifications in **Section 37.0 "Electrical Specifications"**.

5: INTF is enabled to be set any time during the Q4-Q1 cycles.

REGISTER 7-11: PIR0: PERIPHERAL INTERRUPT STATUS REGISTER 0

U-0	U-0	R/W/HS-0/0	R-0	U-0	U-0	U-0	R/W/HS-0/0
—	—	TMR0IF	IOCIF	—	—	—	INTF(1)
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS= Hardware Set

bit 7-6 **Unimplemented:** Read as '0'

bit 5 **TMR0IF:** TMR0 Overflow Interrupt Flag bit
- 1 = TMR0 register has overflowed (must be cleared in software)
- 0 = TMR0 register did not overflow

bit 4 **IOCIF:** Interrupt-on-Change Interrupt Flag bit (read-only)(2)
- 1 = One or more of the IOCAF-IOCEF register bits are currently set, indicating an enabled edge was detected by the IOC module.
- 0 = None of the IOCAF-IOCEF register bits are currently set

bit 3-1 **Unimplemented:** Read as '0'

bit 0 **INTF:** INT External Interrupt Flag bit(1)
- 1 = The INT external interrupt occurred (must be cleared in software)
- 0 = The INT external interrupt did not occur

Note 1: The External Interrupt GPIO pin is selected by INTPPS (Register 13-1).

2: The IOCIF bits are the logical OR of all the IOCAF-IOCEF flags. Therefore, to clear the IOCIF flag, application firmware should clear all of the lower level IOCAF-IOCEF register bits.

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Enable bit, GIE, of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

10.0 NONVOLATILE MEMORY (NVM) CONTROL

NVM is separated into two types: Program Flash Memory (PFM) and Data EEPROM Memory.

NVM is accessible by using both the FSR and INDF registers, or through the NVMREG register interface.

The write time is controlled by an on-chip timer. The write/erase voltages are generated by an on-chip charge pump rated to operate over the operating voltage range of the device.

NVM can be protected in two ways; by either code protection or write protection.

Code protection ($\overline{CP}$ and $\overline{CPD}$ bits in Configuration Word 5) disables access, reading and writing, to both the PFM and EEPROM via external device programmers. Code protection does not affect the self-write and erase functionality. Code protection can only be Reset by a device programmer performing a Bulk Erase to the device, clearing all nonvolatile memory, Configuration bits, and User IDs.

Write protection prohibits self-write and erase to a portion or all of the PFM, as defined by the WRT<1:0> bits of Configuration Word 4. Write protection does not affect a device programmer's ability to read, write, or erase the device.

10.1 Program Flash Memory (PFM)

PFM consists of an array of 14-bit words as user memory, with additional words for User ID information, Configuration words, and interrupt vectors. PFM provides storage locations for:

- User program instructions
- User defined data

PFM data can be read and/or written to through:

- CPU instruction fetch (read-only)
- FSR/INDF indirect access (read-only) (**Section 10.3 "FSR and INDF Access"**)
- NVMREG access (**Section 10.4 "NVMREG Access"**
- In-Circuit Serial Programming™ (ICSP™)

Read operations return a single word of memory. When write and erase operations are done on a row basis, the row size is defined in Table 10-1. PFM will erase to a logic '1' and program to a logic '0'.

TABLE 10-1: FLASH MEMORY ORGANIZATION BY DEVICE

Device	Row Erase (words)	Write Latches (words)	Total Program Flash (words)
PIC16(L)F18854	32	32	4096

It is important to understand the PFM memory structure for erase and programming operations. PFM is arranged in rows. A row consists of 32 14-bit program memory words. A row is the minimum size that can be erased by user software.

After a row has been erased, all or a portion of this row can be programmed. Data to be written into the program memory row is written to 14-bit wide data write latches. These latches are not directly accessible, but may be loaded via sequential writes to the NVMDATH:NVMDATL register pair.

Note:	To modify only a portion of a previously programmed row, then the contents of the entire row must be read and saved in RAM prior to the erase. Then, the new data and retained data can be written into the write latches to reprogram the row of PFM. However, any unprogrammed locations can be written without first erasing the row. In this case, it is not necessary to save and rewrite the other previously programmed locations

10.1.1 PROGRAM MEMORY VOLTAGES

The PFM is readable and writable during normal operation over the full V_{DD} range.

10.1.1.1 Programming Externally

The program memory cell and control logic support write and Bulk Erase operations down to the minimum device operating voltage. Special BOR operation is enabled during Bulk Erase (**Section 5.2.4 "BOR is always OFF"**).

10.1.1.2 Self-programming

The program memory cell and control logic will support write and row erase operations across the entire V_{DD} range. Bulk Erase is not supported when self-programming.

10.4.9 WRERR BIT

The WRERR bit can be used to determine if a write error occurred.

WRERR will be set if one of the following conditions occurs:

- If WR is set while the NVMADRH:NMVADRL points to a write-protected address
- A Reset occurs while a self-write operation was in progress
- An unlock sequence was interrupted

The WRERR bit is normally set by hardware, but can be set by the user for test purposes. Once set, WRERR must be cleared in software.

TABLE 10-4: ACTIONS FOR PFM WHEN WR = 1

Free	LWLO	Actions for PFM when WR = 1	Comments
1	x	Erase the 32-word row of NVMADRH:NVMADRL location. See **Section 10.4.3 "NVMREG Write to EEPROM"**	• If WP is enabled, WR is cleared and WRERR is set • All 32 words are erased • NVMDATH:NVMDATL is ignored
0	1	Copy NVMDATH:NVMDATL to the write latch corresponding to NVMADR LSBs. See **Section 10.4.4 "NVMREG Erase of PFM"**	• Write protection is ignored • No memory access occurs
0	0	Write the write-latch data to PFM row. See **Section 10.4.4 "NVMREG Erase of PFM"**	• If WP is enabled, WR is cleared and WRERR is set • Write latches are reset to 3FFh • NVMDATH:NVMDATL is ignored

REGISTER 12-10: CCDPA: CURRENT-CONTROLLED DRIVE POSITIVE PORTA REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
CCDPA7	CCDPA6	CCDPA5	CCDPA4	CCDPA3	CCDPA2	CCDPA1	CCDPA0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **CCDPA<7:0>:** RA<7:0> Current-Controlled Drive Positive Control bits
1 = Current-controlled source enabled(1)
0 = Current-controlled source disabled

Note 1: If CCDPAy is set, when CCDEN = 0 (Register 12-1), operation of the pin is undefined.

REGISTER 12-11: CCDNA: CURRENT-CONTROLLED DRIVE NEGATIVE PORTA REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
CCDNA7	CCDNA6	CCDNA5	CCDNA4	CCDNA3	CCDNA2	CCDNA1	CCDNA0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **CCDNA<7:0>:** RA<7:0> Current-Control Drive Negative Control bits
1 = Current-controlled source enabled(1)
0 = Current-controlled source disabled

Note 1: If CCDNAy is set when CCDEN = 0 (Register 12-1), operation of the pin is undefined.

12.8.8 CURRENT-CONTROLLED DRIVE MODE CONTROL

The CCDPC and CCDNC registers (Register 12-30 and Register 12-31) control the Current-Controlled Drive mode for both the positive-going and negative-going drivers. When a CCDPC[y] or CCDNC[y] bit is set and the CCDEN bit of the CCDCON register is set, the Current-Controlled mode is enabled for the corresponding port pin. When the CCDPC[y] or CCDNC[y] bit is clear, the Current-Controlled mode for the corresponding port pin is disabled. If the CCDPC[y] or CCDNC[y] bit is set and the CCDEN bit is clear, operation of the port pin is undefined (see **Section 12.1.1 "Current-Controlled Drive"** for current-controlled use precautions).

12.8.9 PORTC FUNCTIONS AND OUTPUT PRIORITIES

Each pin defaults to the PORT latch data after Reset. Other output functions are selected with the peripheral pin select logic. See **Section 13.0 "Peripheral Pin Select (PPS) Module"** for more information.

Analog input functions, such as ADC and comparator inputs, are not shown in the peripheral pin select lists. Digital output functions may continue to control the pin when it is in Analog mode.

TABLE 12-4: SUMMARY OF REGISTERS ASSOCIATED WITH PORTC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	200
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	200
LATC	LATC7	LATC6	LATC5	LATC4	LATC3	LATC2	LATC1	LATC0	200
ANSELC	ANSC7	ANSC6	ANSC5	ANSC4	ANSC3	ANSC2	ANSC1	ANSC0	201
WPUC	WPUC7	WPUC6	WPUC5	WPUC4	WPUC3	WPUC2	WPUC1	WPUC0	201
ODCONC	ODCC7	ODCC6	ODCC5	ODCC4	ODCC3	ODCC2	ODCC1	ODCC0	202
SLRCONC	SLRC7	SLRC6	SLRC5	SLRC4	SLRC3	SLRC2	SLRC1	SLRC0	202
INLVLC	INLVLC7	INLVLC6	INLVLC5	INLVLC4	INLVLC3	INLVLC2	INLVLC1	INLVLC0	202
CCDPC	CCDPC7	CCDPC6	CCDPC5	CCDPC4	CCDPC3	CCDPC2	CCDPC1	CCDPC0	203
CCDNC	CCDNC7	CCDNC6	CCDNC5	CCDNC4	CCDNC3	CCDNC2	CCDNC1	CCDNC0	203
CCDCON	CCDEN	—	—	—	—	—	CCDS<1:0>		181

Legend: – = unimplemented locations read as '0'. Shaded cells are not used by PORTC.

TABLE 23-6: SUMMARY OF REGISTERS ASSOCIATED WITH ADC

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ADCON0	ADON	ADCONT	—	ADCS	—	ADFRM0	—	ADGO	322
ADCON1	ADPPOL	ADIPEN	ADGPOL	—	—	—	—	ADDSEN	323
ADCON2	ADPSIS	ADCRS<2:0>			ADACLR	ADMD<2:0>			324
ADCON3	—	ADCALC<2:0>			ADSOI	ADTMD<2:0>			325
ADACT	—	—	—	ADACT<4:0>					324
ADACCH	ADACCH								334
ADACCL	ADACCL								334
ADPREVH	ADPREVH								333
ADPREVL	ADPREVL								334
ADRESH	ADRESH								332
ADRESL	ADRESL								332
ADSTAT	ADAOV	ADUTHR	ADLTHR	ADMATH	—	ADSTAT<2:0>			326
ADCLK	—	—	ADCCS<5:0>						327
ADREF	—	—	—	ADNREF	—	—	ADPREF<1:0>		327
ADCAP	—	—	—	ADCAP<4:0>					330
ADPRE	ADPRE<7:0>								329
ADACQ	ADACQ<7:0>								329
ADPCH	—	—	ADPCH<5:0>						328
ADCNT	ADCNT<7:0>								331
ADRPT	ADRPT<7:0>								330
ADLTHL	ADLTH<7:0>								336
ADLTHH	ADLTH<15:8>								336
ADUTHL	ADUTH<7:0>								337
ADUTHH	ADUTH<15:8>								337
ADSTPTL	ADSTPT<7:0>								335
ADSTPTH	ADSTPT<15:8>								335
ADFLTRL	ADFLTR<7:0>								331
ADFLTRH	ADFLTR<15:8>								331
ADERRL	ADERR<7:0>								336
ADERRH	ADERR<15:8>								335
ANSELA	ANSA7	ANSA6	ANSA5	ANSA4	ANSA3	ANSA2	ANSA1	ANSA0	185
ANSELB	ANSB7	ANSB6	ANSB5	ANSB4	ANSB3	ANSB2	ANSB1	ANSB0	193
ANSELC	ANSC7	ANSC6	ANSC5	ANSC4	ANSC3	ANSC2	ANSC1	ANSC0	201
DAC1CON1	—	—	—	DAC1R<4:0>					354
FVRCON	FVREN	FVRRDY	TSEN	TSRNG	CDAFVR<1:0>		ADFVR<1:0>		234
INTCON	GIE	PEIE	—	—	—	—	—	INTEDG	114
PIE1	OSFIE	CSWIE	—	—	—	—	ADTIE	ADIE	116
PIR1	OSFIF	CSWIF	—	—	—	—	ADTIF	ADIF	125
OSCSTAT	EXTOR	HFOR	MFOR	LFOR	SOR	ADOR	—	PLLR	104

Legend: – = unimplemented read as '0'. Shaded cells are not used for the ADC module.

Note 1: only.

REGISTER 26-5: MDCARL: MODULATION LOW CARRIER CONTROL REGISTER

U-0	U-0	U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	—	—	MDCLS<3:0>(1)			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

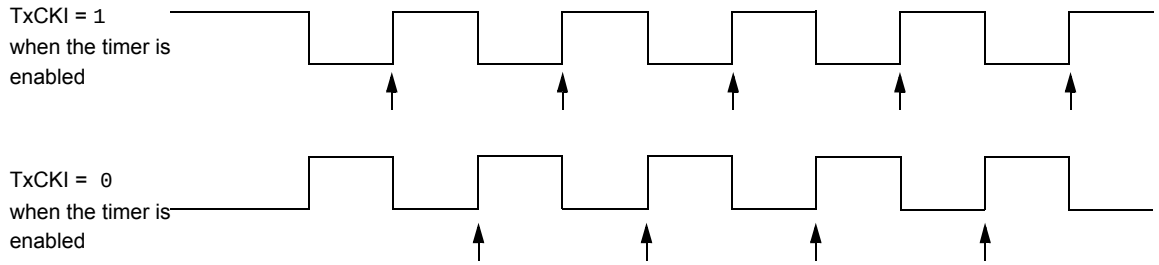
bit 7-4 **Unimplemented:** Read as '0'

bit 3-0 **MDCLS<3:0>** Modulator Data High Carrier Selection bits (1)

1111 = LC4_out
1110 = LC3_out
1101 = LC2_out
1100 = LC1_out
1011 = NCO output
1010 = PWM7_out
1001 = PWM6_out
1000 = CCP5 output (PWM Output mode only)
0111 = CCP4 output (PWM Output mode only)
0110 = CCP3 output (PWM Output mode only)
0101 = CCP2 output (PWM Output mode only)
0100 = CCP1 output (PWM Output mode only)
0011 = Reference clock module signal (CLKR)
0010 = HFINTOSC
0001 = FOSC
0000 = Pin selected by MDCARLPPS

Note 1: Narrowed carrier pulse widths or spurs may occur in the signal stream if the carrier is not synchronized.

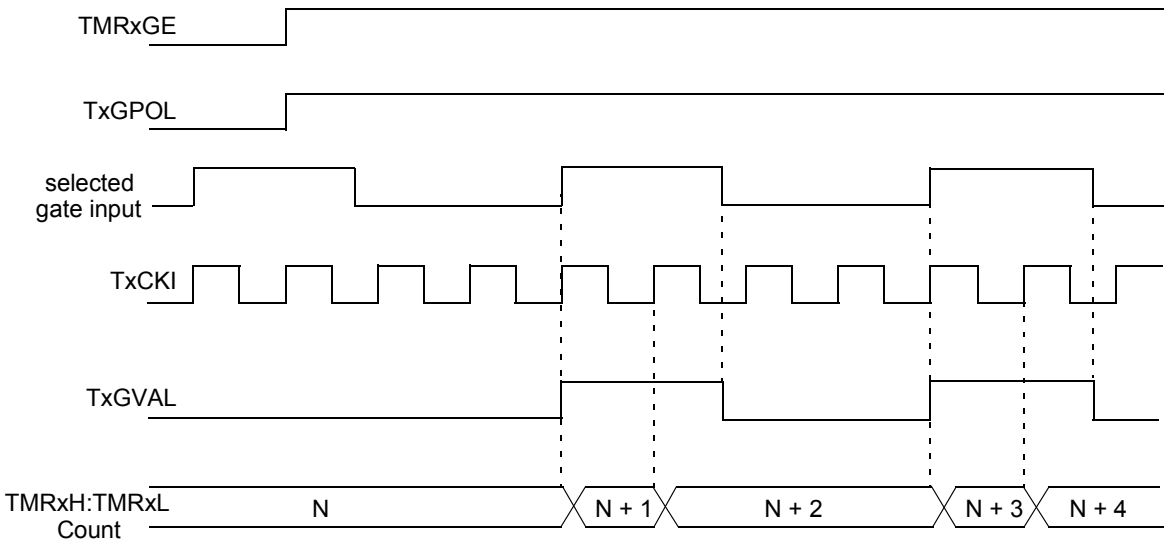
FIGURE 28-2: TIMER1 INCREMENTING EDGE



Note 1: Arrows indicate counter increments.

2: In Counter mode, a falling edge must be registered by the counter prior to the first incrementing rising edge of the clock.

FIGURE 28-3: TIMER1 GATE ENABLE MODE



31.2.4 SPI SLAVE MODE

In Slave mode, the data is transmitted and received as external clock pulses appear on SCK. When the last bit is latched, the SSPxIF interrupt flag bit is set.

Before enabling the module in SPI Slave mode, the clock line must match the proper Idle state. The clock line can be observed by reading the SCK pin. The Idle state is determined by the CKP bit of the SSPxCON1 register.

While in Slave mode, the external clock is supplied by the external clock source on the SCK pin. This external clock must meet the minimum high and low times as specified in the electrical specifications.

While in Sleep mode, the slave can transmit/receive data. The shift register is clocked from the SCK pin input and when a byte is received, the device will generate an interrupt. If enabled, the device will wake-up from Sleep.

31.2.4.1 Daisy-Chain Configuration

The SPI bus can sometimes be connected in a daisy-chain configuration. The first slave output is connected to the second slave input, the second slave output is connected to the third slave input, and so on. The final slave output is connected to the master input. Each slave sends out, during a second group of clock pulses, an exact copy of what was received during the first group of clock pulses. The whole chain acts as one large communication shift register. The daisy-chain feature only requires a single Slave Select line from the master device.

Figure 31-7 shows the block diagram of a typical daisy-chain connection when operating in SPI mode.

In a daisy-chain configuration, only the most recent byte on the bus is required by the slave. Setting the BOEN bit of the SSPxCON3 register will enable writes to the SSPxBUF register, even if the previous byte has not been read. This allows the software to ignore data that may not apply to it.

31.2.5 SLAVE SELECT SYNCHRONIZATION

The Slave Select can also be used to synchronize communication. The Slave Select line is held high until the master device is ready to communicate. When the Slave Select line is pulled low, the slave knows that a new transmission is starting.

If the slave fails to receive the communication properly, it will be reset at the end of the transmission, when the Slave Select line returns to a high state. The slave is then ready to receive a new transmission when the Slave Select line is pulled low again. If the Slave Select line is not used, there is a risk that the slave will eventually become out of sync with the master. If the slave misses a bit, it will always be one bit off in future transmissions. Use of the Slave Select line allows the slave and master to align themselves at the beginning of each transmission.

The $\overline{SS}$ pin allows a Synchronous Slave mode. The SPI must be in Slave mode with $\overline{SS}$ pin control enabled (SSPxCON1<3:0> = 0100).

When the $\overline{SS}$ pin is low, transmission and reception are enabled and the SDO pin is driven.

When the $\overline{SS}$ pin goes high, the SDO pin is no longer driven, even if in the middle of a transmitted byte and becomes a floating output. External pull-up/pull-down resistors may be desirable depending on the application.

Note 1:	When the SPI is in Slave mode with $\overline{SS}$ pin control enabled (SSPxCON1<3:0> = 0100), the SPI module will reset if the $\overline{SS}$ pin is set to VDD.
2:	When the SPI is used in Slave mode with CKE set; the user must enable $\overline{SS}$ pin control.
3:	While operated in SPI Slave mode the SMP bit of the SSPxSTAT register must remain clear.

When the SPI module resets, the bit counter is forced to '0'. This can be done by either forcing the $\overline{SS}$ pin to a high level or clearing the SSPEN bit.

31.5.4 SLAVE MODE 10-BIT ADDRESS RECEPTION

This section describes a standard sequence of events for the MSSP module configured as an I^2C slave in 10-bit Addressing mode.

Figure 31-20 is used as a visual reference for this description.

This is a step by step process of what must be done by slave software to accomplish I^2C communication.

1. Bus starts Idle.
2. Master sends Start condition; S bit of SSPxSTAT is set; SSPxIF is set if interrupt on Start detect is enabled.
3. Master sends matching high address with R/$\overline{W}$ bit clear; UA bit of the SSPxSTAT register is set.
4. Slave sends $\overline{ACK}$ and SSPxIF is set.
5. Software clears the SSPxIF bit.
6. Software reads received address from SSPxBUF clearing the BF flag.
7. Slave loads low address into SSPxADD, releasing SCL.
8. Master sends matching low address byte to the slave; UA bit is set.

Note: Updates to the SSPxADD register are not allowed until after the $\overline{ACK}$ sequence.

9. Slave sends $\overline{ACK}$ and SSPxIF is set.

Note: If the low address does not match, SSPxIF and UA are still set so that the slave software can set SSPxADD back to the high address. BF is not set because there is no match. CKP is unaffected.

10. Slave clears SSPxIF.
11. Slave reads the received matching address from SSPxBUF clearing BF.
12. Slave loads high address into SSPxADD.
13. Master clocks a data byte to the slave and clocks out the slaves $\overline{ACK}$ on the ninth SCL pulse; SSPxIF is set.
14. If SEN bit of SSPxCON2 is set, CKP is cleared by hardware and the clock is stretched.
15. Slave clears SSPxIF.
16. Slave reads the received byte from SSPxBUF clearing BF.
17. If SEN is set the slave sets CKP to release the SCL.
18. Steps 13-17 repeat for each received byte.
19. Master sends Stop to end the transmission.

31.5.5 10-BIT ADDRESSING WITH ADDRESS OR DATA HOLD

Reception using 10-bit addressing with AHEN or DHEN set is the same as with 7-bit modes. The only difference is the need to update the SSPxADD register using the UA bit. All functionality, specifically when the CKP bit is cleared and SCL line is held low are the same. Figure 31-21 can be used as a reference of a slave in 10-bit addressing with AHEN set.

Figure 31-22 shows a standard waveform for a slave transmitter in 10-bit Addressing mode.

31.6.10 SLEEP OPERATION

While in Sleep mode, the I^2C slave module can receive addresses or data and when an address match or complete byte transfer occurs, wake the processor from Sleep (if the MSSP interrupt is enabled).

31.6.11 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

31.6.12 MULTI-MASTER MODE

In Multi-Master mode, the interrupt generation on the detection of the Start and Stop conditions allows the determination of when the bus is free. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I^2C bus may be taken when the P bit of the SSPxSTAT register is set, or the bus is Idle, with both the S and P bits clear. When the bus is busy, enabling the SSP interrupt will generate the interrupt when the Stop condition occurs.

In multi-master operation, the SDA line must be monitored for arbitration to see if the signal level is the expected output level. This check is performed by hardware with the result placed in the BCL1IF bit.

The states where arbitration can be lost are:

- Address Transfer
- Data Transfer
- A Start Condition
- A Repeated Start Condition
- An Acknowledge Condition

31.6.13 MULTI -MASTER COMMUNICATION, BUS COLLISION AND BUS ARBITRATION

Multi-Master mode support is achieved by bus arbitration. When the master outputs address/data bits onto the SDA pin, arbitration takes place when the master outputs a '1' on SDA, by letting SDA float high and another master asserts a '0'. When the SCL pin floats high, data should be stable. If the expected data on SDA is a '1' and the data sampled on the SDA pin is '0', then a bus collision has taken place. The master will set the Bus Collision Interrupt Flag, BCL1IF and reset the I^2C port to its Idle state (Figure 31-32).

If a transmit was in progress when the bus collision occurred, the transmission is halted, the BF flag is cleared, the SDA and SCL lines are deasserted and the SSPxBUF can be written to. When the user services the bus collision Interrupt Service Routine and if the I^2C bus is free, the user can resume communication by asserting a Start condition.

If a Start, Repeated Start, Stop or Acknowledge condition was in progress when the bus collision occurred, the condition is aborted, the SDA and SCL lines are deasserted and the respective control bits in the SSPxCON2 register are cleared. When the user services the bus collision Interrupt Service Routine and if the I^2C bus is free, the user can resume communication by asserting a Start condition.

The master will continue to monitor the SDA and SCL pins. If a Stop condition occurs, the SSPxIF bit will be set.

A write to the SSPxBUF will start the transmission of data at the first data bit, regardless of where the transmitter left off when the bus collision occurred.

In Multi-Master mode, the interrupt generation on the detection of Start and Stop conditions allows the determination of when the bus is free. Control of the I^2C bus can be taken when the P bit is set in the SSPxSTAT register, or the bus is Idle and the S and P bits are cleared.

FIGURE 31-32: BUS COLLISION TIMING FOR TRANSMIT AND ACKNOWLEDGE

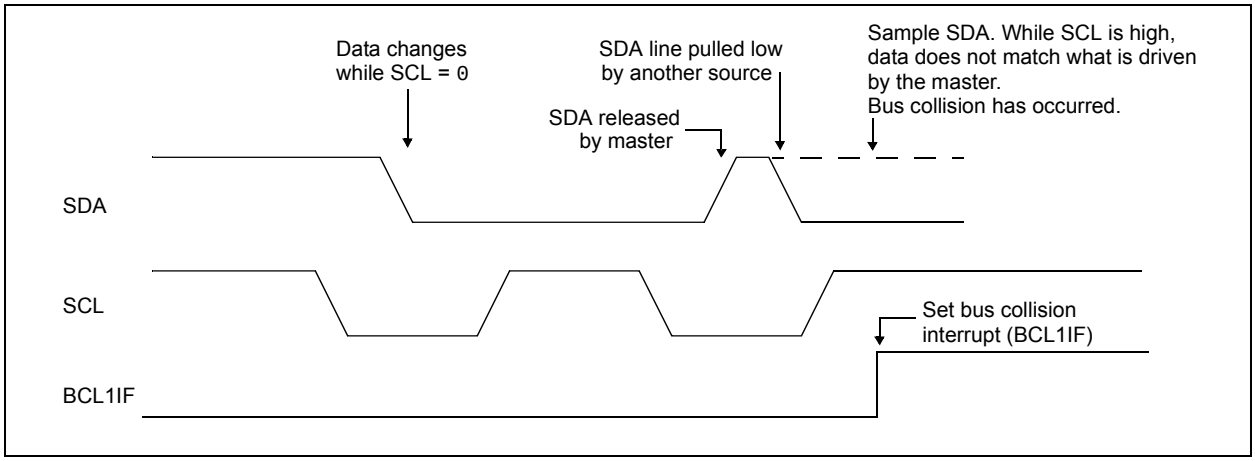


FIGURE 32-13: GATED WINDOWED MEASURE MODE SINGLE ACQUISITION TIMING DIAGRAMS

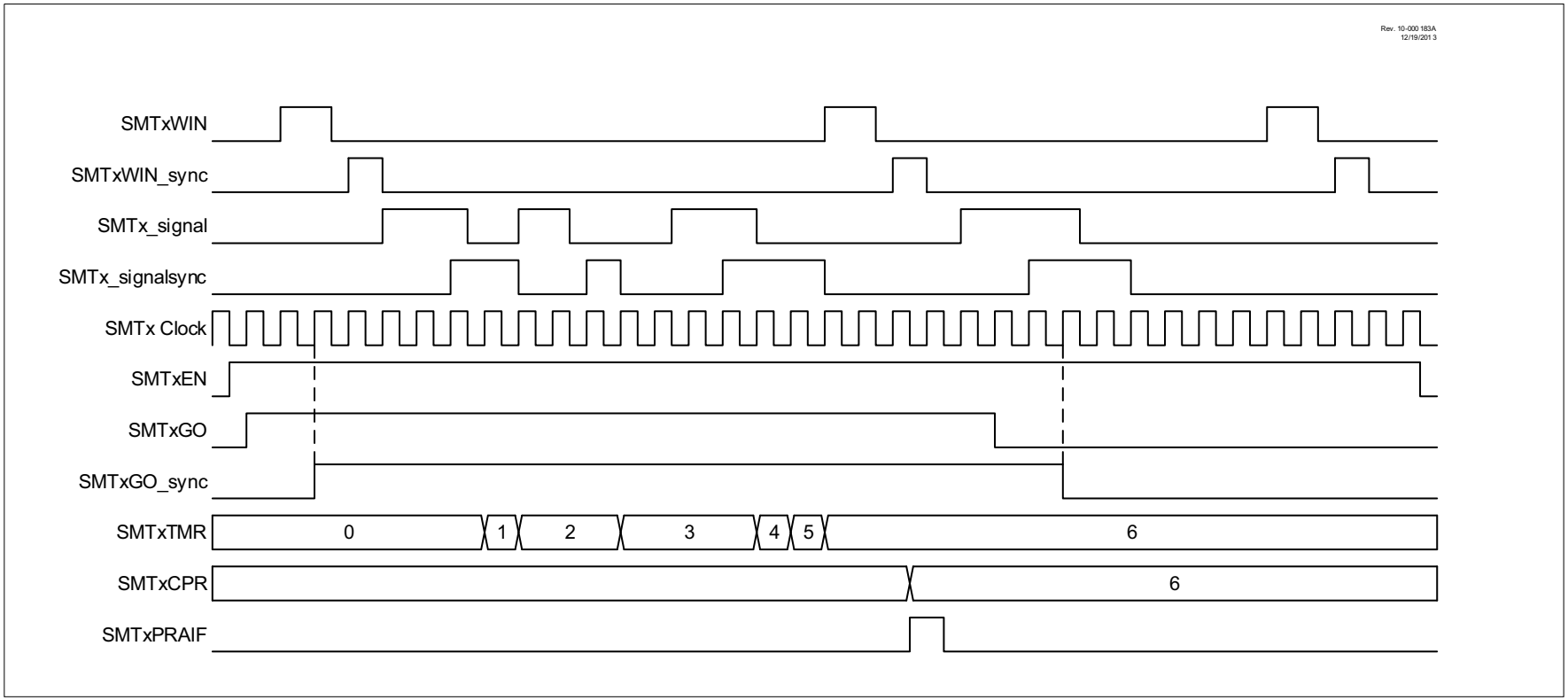
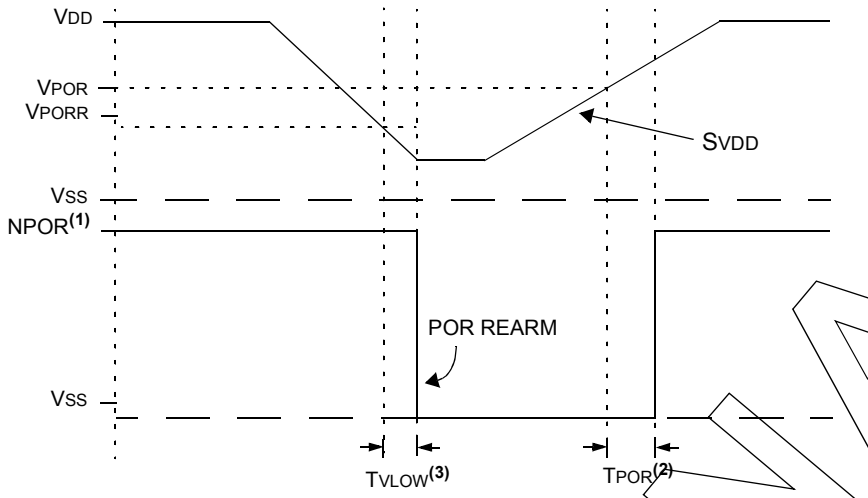
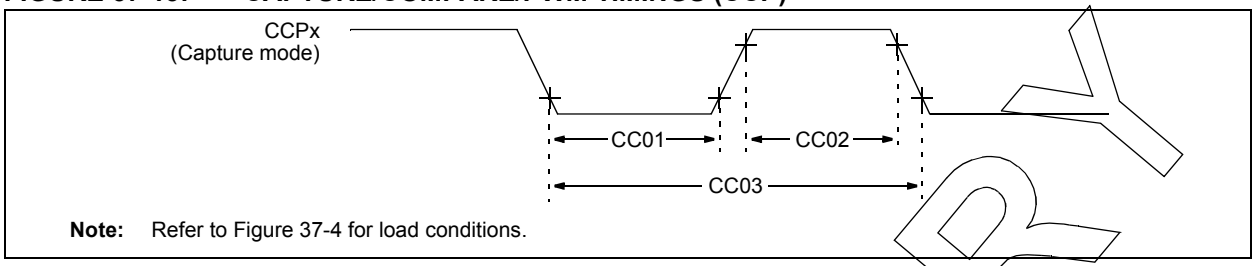


FIGURE 37-3: POR AND POR REARM WITH SLOW RISING VDD



Note 1: When NPOR is low, the device is held in Reset.
2: TPOR 1 μs typical.
3: TVLOW 2.7 μs typical.

FIGURE 37-13: CAPTURE/COMPARE/PWM TIMINGS (CCP)



Note: Refer to Figure 37-4 for load conditions.

TABLE 37-19: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP)

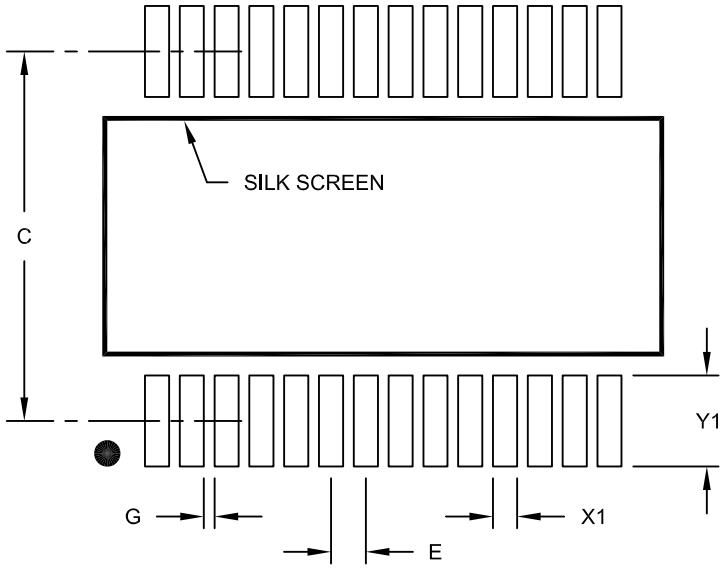
Standard Operating Conditions (unless otherwise stated) Operating Temperature -40°C ≤ TA ≤ +125°C								
Param. No.	**Sym.**	**Characteristic**		**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
CC01*	TccL	CCPx Input Low Time	No Prescaler	0.5TCY + 20	—	—	ns	
			With Prescaler	20	—	—	ns	
CC02*	TccH	CCPx Input High Time	No Prescaler	0.5TCY + 20	—	—	ns	
			With Prescaler	20	—	—	ns	
CC03*	TccP	CCPx Input Period		$\frac{3T_{CY} + 40}{N}$	—	—	ns	N = prescale value

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Contact Pad Spacing	C		7.20	
Contact Pad Width (X28)	X1			0.45
Contact Pad Length (X28)	Y1			1.75
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2073A